PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT5094808

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHOGO MOCHIZUKI	08/13/2018
KANGGUO CHENG	08/10/2018
JUNTAO LI	08/11/2018
CHOONGHYUN LEE	08/10/2018

RECEIVING PARTY DATA

Name:	INTERNATIONAL BUSINESS MACHINES CORPORATION
Street Address:	NEW ORCHARD ROAD
City:	ARMONK
State/Country:	NEW YORK
Postal Code:	10504

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16102110

CORRESPONDENCE DATA

Fax Number: (631)393-6271

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 631-393-6270

Email: nyoffice@rml-law.com **Correspondent Name:** MICHAEL F. MORANO

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Address Line 2: RYAN, MASON & LEWIS, LLP Address Line 4: MELVILLE, NEW YORK 11747

ATTORNEY DOCKET NUMBER:	P201802218US01	
NAME OF SUBMITTER:	MICHAEL F. MORANO	
SIGNATURE:	/michael f. morano/	
DATE SIGNED:	08/13/2018	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 5

PATENT REEL: 046629 FRAME: 0250 source=P201802218US01_ASM-DEC#page1.tif source=P201802218US01_ASM-DEC#page2.tif source=P201802218US01_ASM-DEC#page3.tif source=P201802218US01_ASM-DEC#page4.tif source=P201802218US01_ASM-DEC#page5.tif

> PATENT REEL: 046629 FRAME: 0251

DECLARATION (37 C.F.R. § 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. § 1.76) AND ASSIGNMENT

Title of Invention: BOTTOM SPACER STRUCTURE FOR VERTICAL FIELD EFFECT TRANSISTOR AND METHOD OF FORMING SAME

As a below named and undersigned inventor, I hereby declare that:
This declaration is directed to the attached application, or (if following box is checked):
[] United States application or PCT international application number
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the contents of the application, including the claims.
I am aware of the duty to disclose to the United States Patent and Trademark Office all information

Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document;

known to me to be material to patentability as defined in 37 C.F.R. § 1.56.

Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a corporation of New York having a place of business at Armonk, New York, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by the ASSIGNEE, its successors, legal representatives, or assigns.

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I acknowledge my prior and ongoing obligations to sell, assign, and transfer my rights under this Assignment to the ASSIGNEE and am unaware of any reason why I may not have the full and unencumbered right to sell, assign, and transfer my rights hereby sold, assigned, and transferred, and have not executed, and will not execute, any document or instrument in conflict herewith. I also hereby grant the ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

Signature:	Date: 8/13/2018
(1) Legal Name of Inventor: Shogo Mochizuki	
Signature:	Date:
(2) Legal Name of Inventor: Kangguo Cheng	
Signature:	Date:
(3) Legal Name of Inventor: Juntao Li	
Signature:	Date:
(4) Legal Name of Inventor: Choonghyun Lee	

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(1) Legal Name of Inventor: Shogo Moch	izuki
Signature:	8/10/2018 Date:
(2) Legal Name of Inventor: Kangguo Cl	neng
a.	D. i
Signature:	Date:
(3) Legal Name of Inventor: Juntao Li	
Signature:	Date:

(4) Legal Name of Inventor: Choonghyun Lee

Page 2 of 2

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Signature:	Date:
(1) Legal Name of Inventor: Shogo Mochizuki	
Signature:	Date:
(2) Legal Name of Inventor: Kangguo Cheng	
Signature:	Date: 8/11/2018
(3) Legal Name of Inventor: Juntao Li	
Signature:	Date:
(4) Legal Name of Inventor: Choonghyun Lee	

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Signature:	Date:
(3) Legal Name of Inventor: Juntao Li	8 ×
Signature: NoongHun	Date: 8//0/20/8
(4) Legal Name of Inventor: Choonghyun Lee	

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